

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	BFP 840ESD H6327	**Issued**	15. April 2021
MA#	MA001351578		
Package	PG-SOT343-4-2	**Weight***	6.93 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	tin	7440-31-5	0.001	0.01		101	
	noble metal	gold	7440-57-5	0.003	0.04		393	
	inorganic material	silicon	7440-21-3	0.024	0.35	0.40	3464	3958
leadframe	inorganic material	silicon	7440-21-3	0.001	0.01		100	
	non noble metal	titanium	7440-32-6	0.003	0.05		498	
	non noble metal	chromium	7440-47-3	0.010	0.15		1493	
	non noble metal	copper	7440-50-8	3.433	49.53	49.74	495496	497587
wire	noble metal	gold	7440-57-5	0.010	0.15	0.15	1469	1469
encapsulation	organic material	carbon black	1333-86-4	0.030	0.44		4370	
	plastics	epoxy resin	-	0.651	9.40		93959	
	inorganic material	silicondioxide	60676-86-0	2.347	33.87	43.71	338689	437018
leadfinish	non noble metal	tin	7440-31-5	0.199	2.88	2.88	28755	28755
plating	noble metal	silver	7440-22-4	0.216	3.12	3.12	31213	31213
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com